SDFS006A - MARCH 1987 - REVISED OCTOBER 1993

 Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

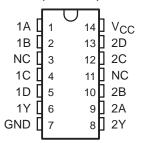
These devices contain two independent 4-input AND gates. They perform the Boolean functions $Y = A \cdot B \cdot C \cdot D$ or $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$ in positive logic.

The SN54F21 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74F21 is characterized for operation from 0°C to 70°C.

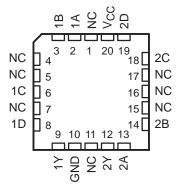
FUNCTION TABLE (each gate)

	INPUTS						
Α	В	С	D	Υ			
Н	Н	Н	Н	Н			
L	Χ	Χ	Χ	L			
X	L	Χ	Χ	L			
Х	Χ	L	Χ	L			
Х	X	X	L	L			

SN54F21 ... J PACKAGE SN74F21 ... D OR N PACKAGE (TOP VIEW)

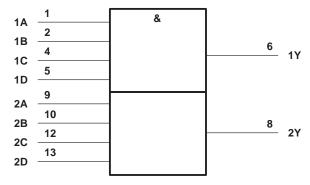


SN54F21 . . . FK PACKAGE (TOP VIEW)



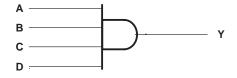
NC - No internal connection

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

logic diagram, each gate (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 1993, Texas Instruments Incorporated

SDFS006A - MARCH 1987 - REVISED OCTOBER 1993

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} ... -0.5 V to 7 V Input voltage range, V_{I} (see Note 1) ... -1.2 V to 7 V Input current range ... -30 mA to 5 mA Voltage range applied to any output in the high state ... -0.5 V to V_{CC} Current into any output in the low state ... 40 mA Operating free-air temperature range: SN54F21 ... $-55^{\circ}C$ to $125^{\circ}C$ SN74F21 ... $0^{\circ}C$ to $70^{\circ}C$ Storage temperature range ... $-65^{\circ}C$ to $150^{\circ}C$

recommended operating conditions

		SN54F21			5			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
liK	Input clamp current			-18			-18	mA
lOH	High-level output current			- 1			- 1	mA
loL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555	TEGT COMPLETIONS		;	SN54F21		5			
PARAMETER	TES	TEST CONDITIONS				MIN	TYP [‡]	MAX	UNIT
VIK	V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
V	V _{CC} = 4.5 V,	I _{OH} = – 1 mA	2.5	3.4		2.5	3.4		V
VOH	$V_{CC} = 4.75 V$,	I _{OH} = – 1 mA				2.7			V
V_{OL}	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 20 \text{ mA}$		0.3	0.5		0.3	0.5	V
lį	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA
lН	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ
I _{IL}	$V_{CC} = 5.5 \text{ V},$	V _I = 0.5 V			- 0.6			- 0.6	mA
los§	$V_{CC} = 5.5 \text{ V},$	VO = 0	-60		-150	-60		-150	mA
^I ССН	$V_{CC} = 5.5 \text{ V},$	V _I = 4.5 V		2.8	4.3		2.8	4.3	mA
ICCL	V _{CC} = 5.5 V,	V _I = 0		4.7	7.3		4.7	7.3	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

SDFS006A - MARCH 1987 - REVISED OCTOBER 1993

switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5 \text{ V},$ $C_{L} = 50 \text{ pF},$ $R_{L} = 500 \Omega,$ $T_{A} = 25^{\circ}\text{C}$			V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX [†]				UNIT
			MIN	′F21 TYP	MAX	SN54 MIN	IF21 MAX	SN74 MIN	F21 MAX	
			4			4		4		
t _{PLH}	A, B, C, or D	Y	1	3.2	4.7	1	5.6	1	5.3	ns
^t PHL	А, В, С, 01 В		1.5	3.4	5.1	1.5	5.9	1.5	5.5	

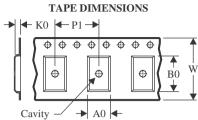
[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and waveforms are shown in Section 1.



www.ti.com 13-May-2025

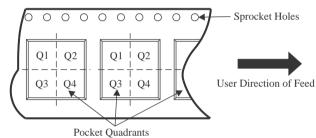
TAPE AND REEL INFORMATION

REEL DIMENSIONS Reel Diameter Reel Width (W1)



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



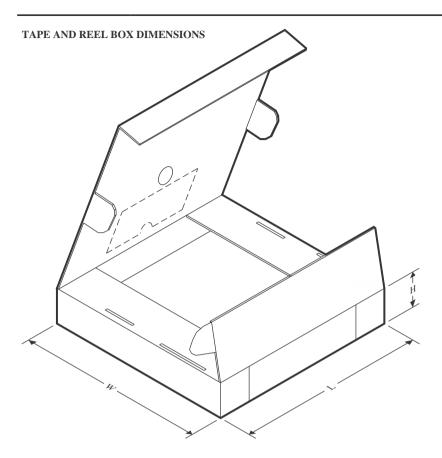
*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F21DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

www.ti.com 13-May-2025



*All dimensions are nominal

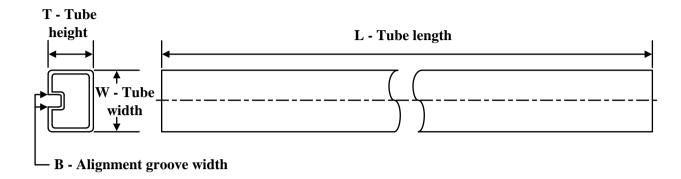
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F21DR	SOIC	D	14	2500	356.0	356.0	35.0





www.ti.com 13-May-2025

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74F21N	N	PDIP	14	25	506	13.97	11230	4.32
SN74F21N	N	PDIP	14	25	506	13.97	11230	4.32

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025. Texas Instruments Incorporated